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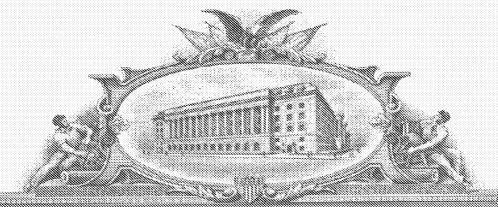
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APPLICATION NUMBER: 60/542,434
FILING DATE: February 05, 2004
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February 5, 2004

Francene Sawyer

U.S. Provisional Patent Application Entitled POWER MOSFET WITH DRAIN SENSE FUNCTION

Inventor(s):

ZHENG SHEN, 438 Pine Brae Dr., Ann Arbor, MI 48105

TITLE

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[0001] POWER MOSFET WITH DRAIN SENSE FUNCTION

FIELD OF THE INVENTION

[0002] This invention generally relates to power semiconductor devices.

5 DESCRIPTION OF THE INVENTION

[0003] The aspects, features and advantages of the present invention will become better understood with regard to the following description with reference to the accompanying drawings. What follows are preferred embodiments of the present invention. It should be apparent to those skilled in the art that the foregoing is illustrative only and not limiting, having been presented by way of example only. All the features disclosed in this description may be replaced by alternative features serving the same purpose, and equivalents or similar purpose, unless expressly stated otherwise. For instance, one skilled in the art can reverse the conductivity types shown in these embodiments as needed and without departing from the spirit or scope of the invention. Likewise, implanted wells may be replace by doped expitaxial layers or other methods used which impart the same conductivity type without departing from the scope of the present invention. Therefore, numerous other embodiments of the modifications thereof are contemplated as falling within the scope of the present invention as defined herein and equivalents thereto. Use of absolute terms, such as "will not," "will," "shall," "shall not," "must," and "must not," are not meant to limit the present invention as the embodiments disclosed herein are merely exemplary.

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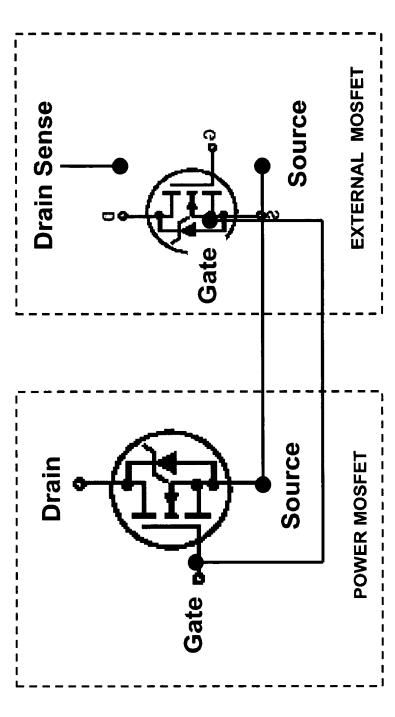
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Discrete Power Mosfet With Integrated Drain Sense Function

- multiple transistors with common Source connection with one or more transistors having electrically isolated Drain Discrete power semiconductor device comprised of and Gate connections
- Discrete power semiconductor device comprised of multiple transistors with common Source and Gate connections with one or more transistors having electrically isolated Drain connections
- substantially different threshold voltages and electrically multiple transistors with common Source and Gate Discrete power semiconductor device comprised of connections with one or more transistors having solated Drain connections რ

Motivation



terminals. Circuitry connected to the Drain Sense terminal can provide Discrete Power MOSFETs are primarily used as high current switching elements. Monitoring the operating conditions of a discrete power MOSFET can be achieved by connecting the corresponding terminals input information to the control circuit to provide circuit protection and of an external MOSFET to the power MOSFET's Gate and Source performance optimization.

Motivation

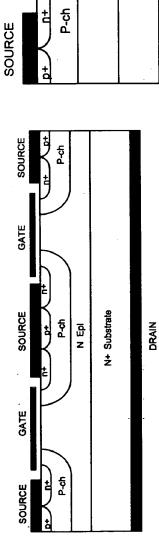
It is advantages to monolithically integrate the sensing transistor with the power MOSFET

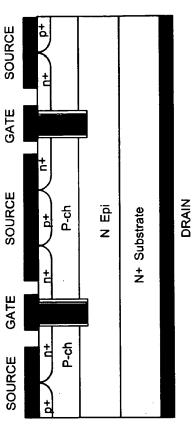
- 1) Eliminates the need for the external MOSFET
- Improved parametric matching of both the power and sense transistor
- established. This allows the sense and power transistor's area dependent The power and sense transistor's relative sizes can be accurately parameters to be accurately ratioed.
- 4) The monolithic integration of both the power and sense transistors feature excellent temperature tracking for improved matching and accuracy.
- 5) The threshold voltages of the power and sense transistor can be adjusted independently for use in applications where this would be advantageous.

Conventional Power MOSFET Structures

VERTICAL PLANAR POWER MOSFET

TRENCH POWER MOSFET



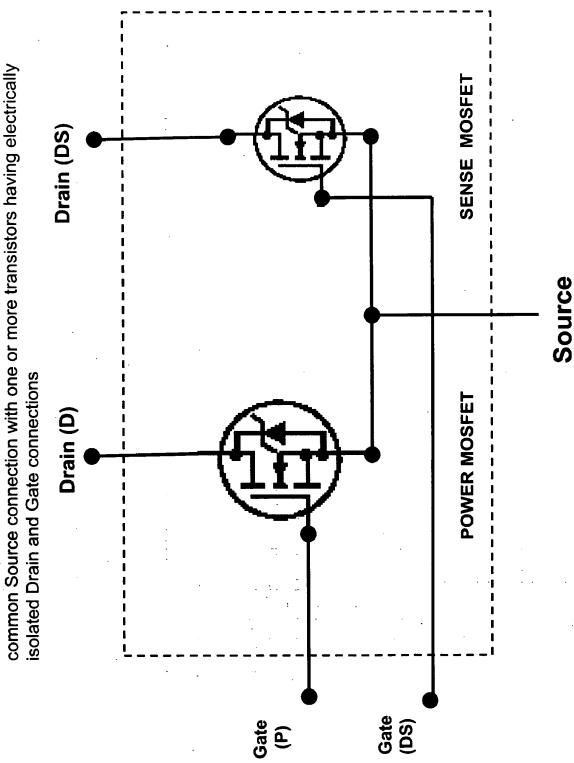


Conventional power MOSFET structures have a common backside Drain contact. It would be very complicated and expensive to monolithically integrate a isolated Drain sense feature into these structures.

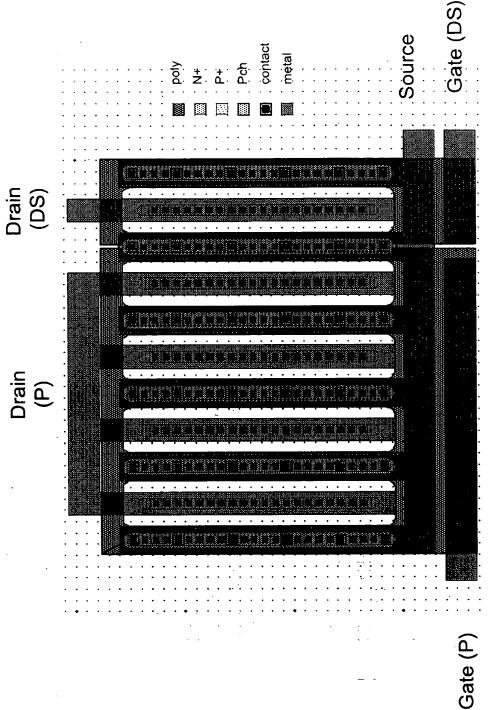
Discrete Power Mosfet With Integrated Drain Sense Function

We have invented a discrete power MOSFET with integrated drain sense functionality by building the discrete power MOSFET using a lateral power MOSFET technology.

1. Discrete power semiconductor device comprised of multiple transistors with common Source connection with one or more transistors having electrically



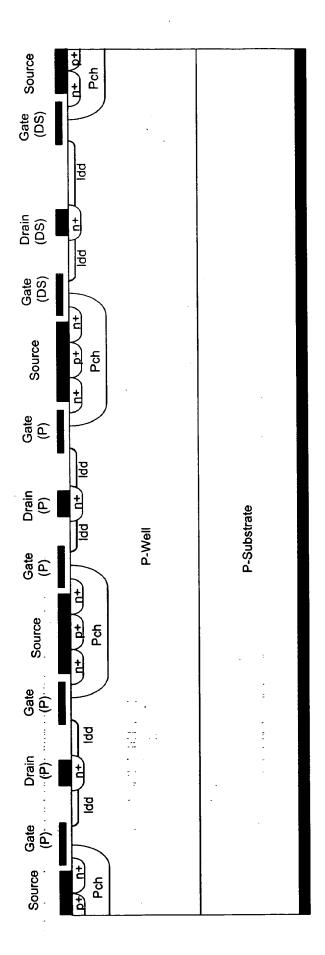
1. Discrete power semiconductor device comprised of multiple transistors with common Source connection with one or more transistors having electrically isolated Drain and Gate connections



Device Layout Showing Drain Sense Design

Page 8

1. Discrete power semiconductor device comprised of multiple transistors with common Source connection with one or more transistors having electrically isolated Drain and Gate connections



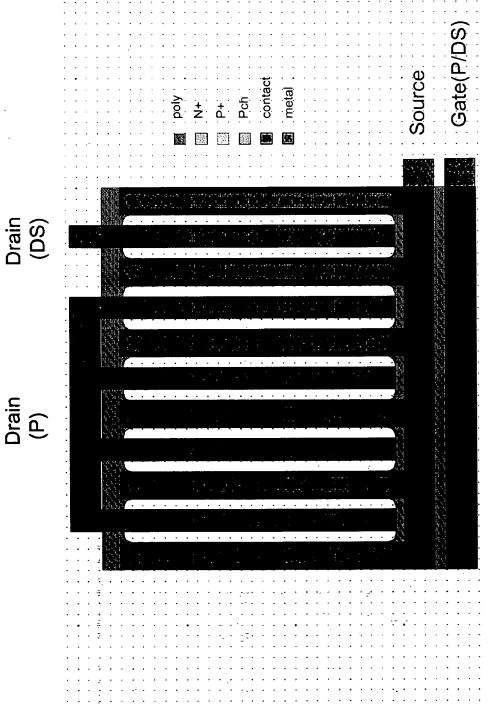
Cross-Sectional Diagram of a Power MOSFET With Integrated Drain Sense

- (P) Indicates Power MOSFET Terminal
- (DS) Indicates Drain Sense MOSFET Terminal

Gate connections with one or more transistors having electrically isolated Drain connections SENSE MOSFET Drain (DS) Source **POWER MOSFET** Drain (P) Gate (P/DS)

2. Discrete power semiconductor device comprised of multiple transistors with common Source and

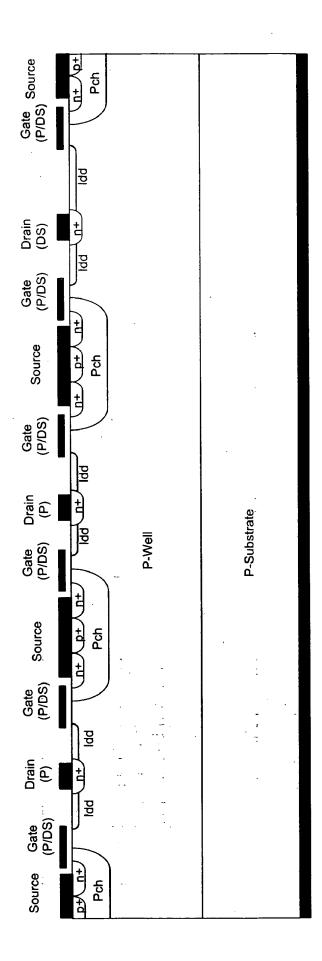
2. Discrete power semiconductor device comprised of multiple transistors with common Source and Gate connections with one or more transistors having electrically isolated Drain connections



Device Layout Showing Drain Sense Design

Page 11

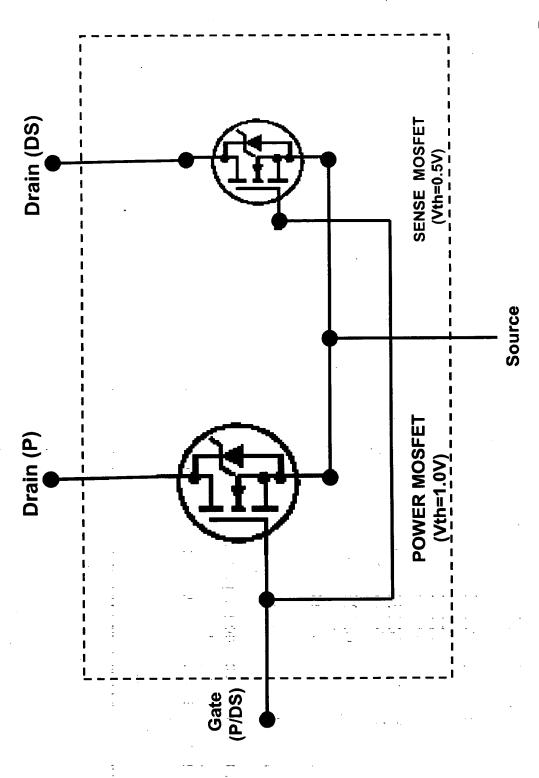
2. Discrete power semiconductor device comprised of multiple transistors with common Source and Gate connections with one or more transistors having electrically isolated Drain connections



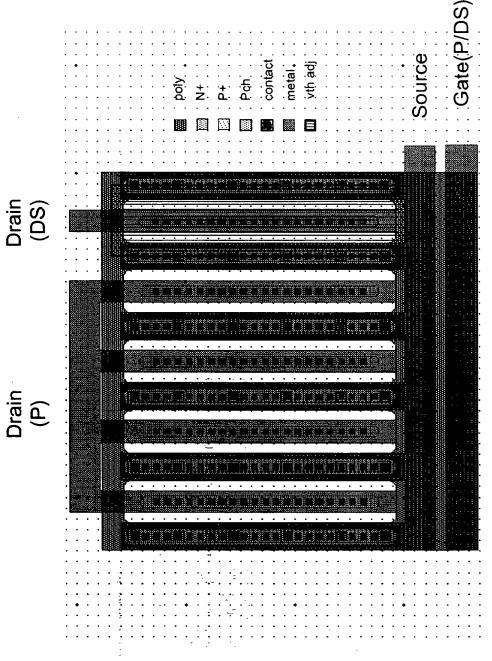
Cross-Sectional Diagram of a Power MOSFET With Integrated Drain Sense

- (P) Indicates Power MOSFET Terminal
- (DS) Indicates Drain Sense MOSFET Terminal

3. Discrete power semiconductor device comprised of multiple transistors with common Source and Gate connections with one or more transistors having substantially different threshold voltages and electrically isolated Drain connections



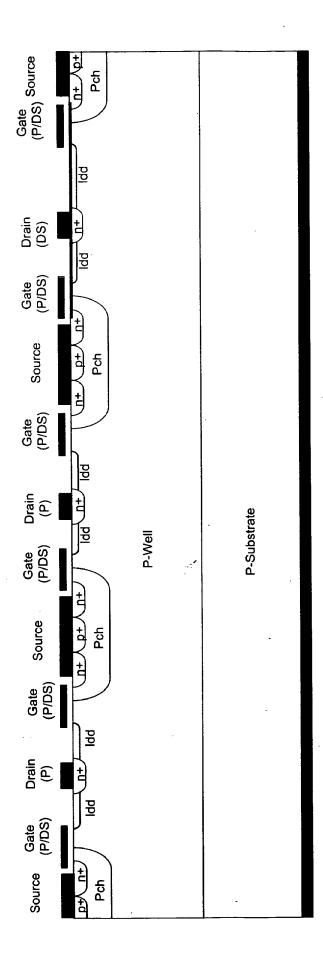
3. Discrete power semiconductor device comprised of multiple transistors with common Source and Gate connections with one or more transistors having substantially different threshold voltages and electrically isolated Drain connections



Device Layout Showing Drain Sense Design

Page 14

3. Discrete power semiconductor device comprised of multiple transistors with common Source and Gate connections with one or more transistors having substantially different threshold voltages and electrically isolated Drain connections



Cross-Sectional Diagram of a Power MOSFET With Integrated Drain Sense

- (P) Indicates Power MOSFET Terminal
- (DS) Indicates Drain Sense MOSFET Terminal
- ---- Indicates Threshold Adjust Implant

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Filing Date:

February 5, 2004

Inventors:

Zheng Shen and David Okada

Title:

POWER MOSFET WITH DRAIN SENSE FUNCTION

Atty Docket No.: 104023-678-PRO

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- 2. Provisional Application of Zheng Shen and David Okada (16 pages);
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